

DESCRIPTION

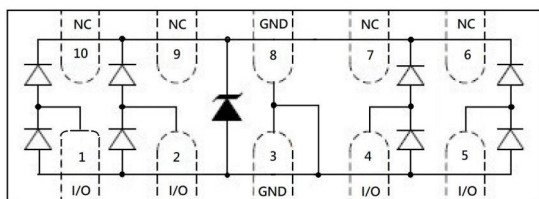
ESDU3V3AG4 is an ultra-low capacitance Transient Voltage Suppressor (TVS) designed to protection for high-speed data interfaces. With typical capacitance of 0.2pF (I/O to I/O) only, ESDU3V3AG4 is designed to protect parasitic-sensitive systems against over-voltage and over-current transient events. It complies with IEC 61000-4-2 (ESD), Level 4(±15KV air, ±8KV contact discharge), IEC61000-4-4 (electrical fast transient-EFT) (40A, 5/50ns), very fast charged device model (CDM)ESD and cable discharge event (CDE),etc.

ESDU3V3AG4 uses ultra-small DFN2510 package. Each ESDU3V3AG4 device can protect four high-speed data lines. The combined features of ultra-low capacitance, ultra-small size and high ESD robustness make ESDU3V3AG4 an ideal for high-speed data ports and high-frequency lines (e.g., HDMI & DVI) applications. The low clamping voltage of the ESDU3V3AG4 guarantees a minimum stress on the protected IC.

ORDERING INFORMATION

- ◇ Package: DFN2510
- ◇ Marking: 3324P
- ◇ Material: Halogen free
- ◇ Packing: Tape & Reel
- ◇ Quantity per reel: 3,000pcs

PIN CONFIGURATION



FEATURES

- ◇ Transient protection for high-speed data lines
IEC61000-4-2(ESD) ±20KV(Contact)
±25KV(Air)
- IEC61000-4-4(EFT)40A(5/50ns)
Cable Discharge Event(CDE)
- ◇ Package optimized for high-speed lines
- ◇ Ultra-small package(2.5mm*1.0mm*0.55mm)
- ◇ Protects four data lines
- ◇ Low capacitance: 0.2pF (I/O to I/O)
- ◇ Low leakage current
- ◇ Low clamping voltage
- ◇ Each I/O pin can withstand over 1000 ESD strikes for ±8KV contact discharge

MACHANICAL DATA

- ◇ DFN2510 package
- ◇ Flammability Rating: UL 94V-0
- ◇ Terminal: Matte tin plated.
- ◇ High temperature soldering guaranteed:
260°C/10s
- ◇ Packaging: Tape and Reel
- ◇ Reel size: 7 inch

APPLICATIONS

- ◇ Serial ATA
- ◇ PCI Express
- ◇ MDDI Ports
- ◇ USB 2.0/3.0 Power and Data Line Protection
- ◇ Display Ports
- ◇ High Definition Multi-Media Interface (HDMI)
- ◇ Digital Visual Interface (DVI)

CIRCUIT DIAGRAM



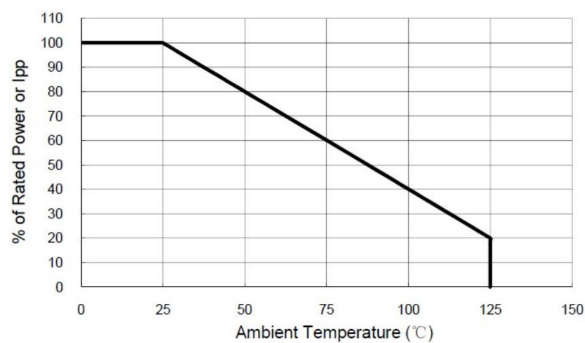
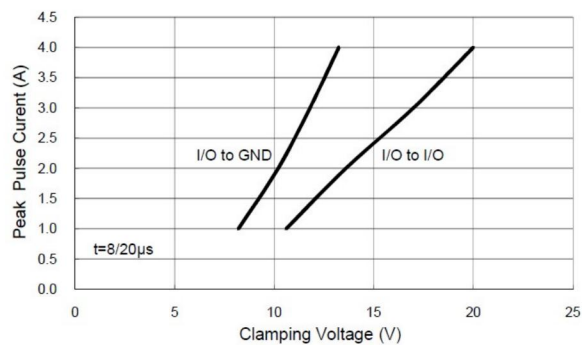
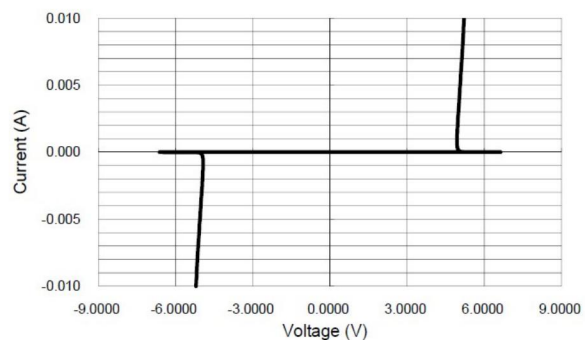
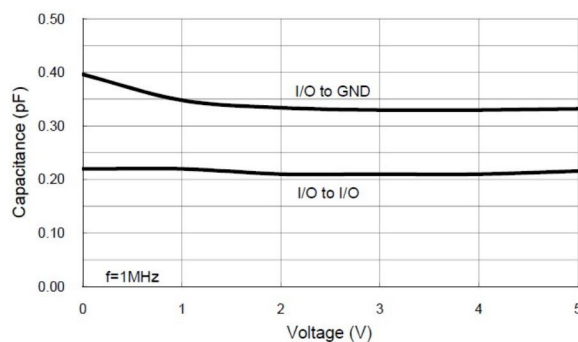
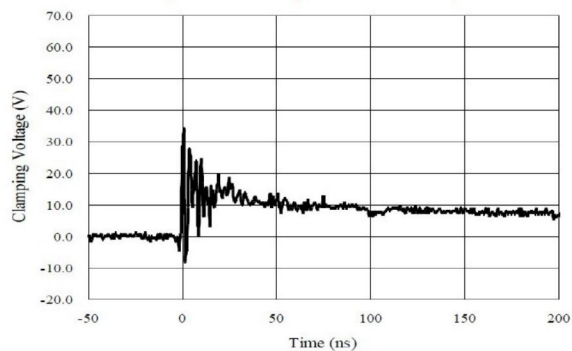
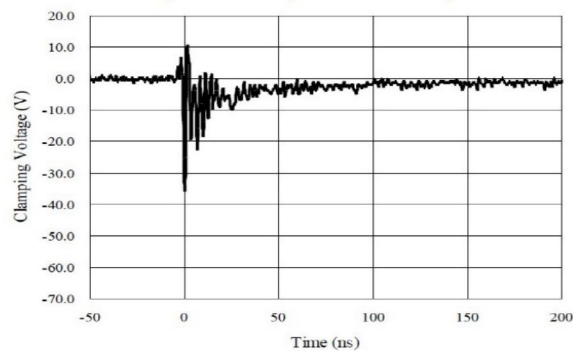
ABSOLUTE MAXIMUM RATING

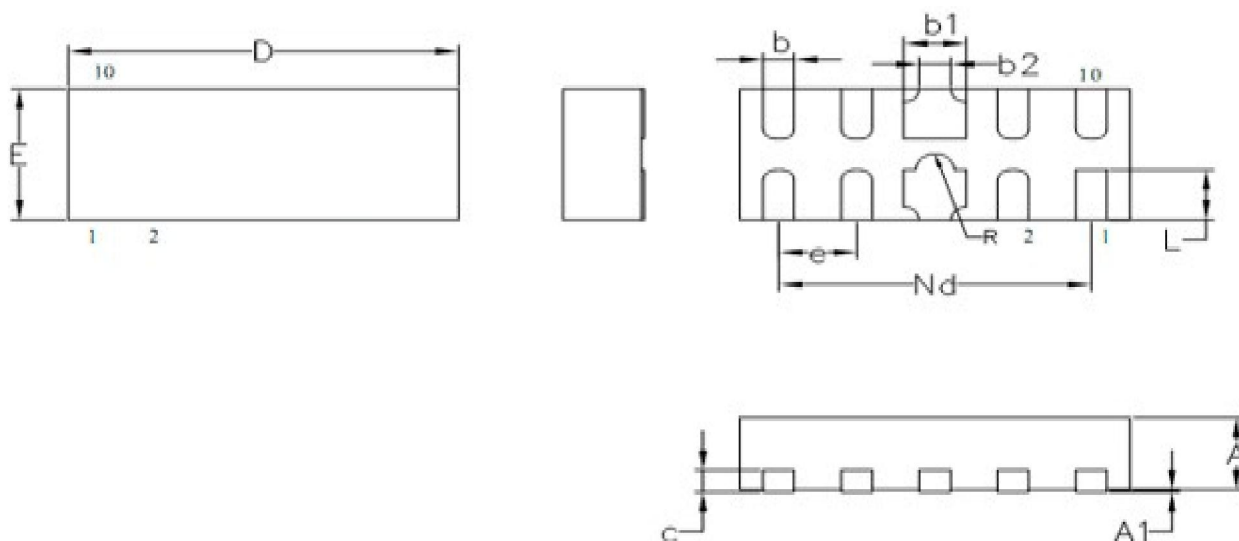
Symbol	Parameter	Value	Units
P_{PP}	Peak Pulse Power (8/20 μ s)	56	W
V_{ESD}	ESD per IEC 61000-4-2 (Air) ESD per IEC 61000-4-2 (Contact)	± 25 ± 20	kV
T_{OPT}	Operating Temperature	-55/+125	°C
T_{STG}	Storage Temperature	-55/+150	°C

ELECTRICAL CHARACTERISTICS (Tamb=25. °C)

Symbol	Parameter	Test Condition	Min	Typ	Max	Units
V_{RWM}	Reverse Working Voltage	Any I/O pin to GND			3.3	V
V_{BR}	Reverse Breakdown Voltage	$I_T = 1mA$ Any I/O pin to GND	4.2			V
I_R	Reverse Leakage Current	$V_{RWM} = 3.3V$ Any I/O pin to GND			1.0	μA
V_C	Clamping Voltage	$I_{PP} = 1A, t_p = 8/20\mu s$ Any I/O pin to GND			10	V
		$I_{PP} = 4A, t_p = 8/20\mu s$ Any I/O pin to GND			14	V
C_{ESD}	Parasitic Capacitance	$V_R = 0V, f = 1MHz$ Between I/O and GND		0.4	0.5	pF
C_{ESD}	Parasitic Capacitance	$V_R = 0V, f = 1MHz$ Between I/O and I/O		0.2	0.3	pF

Note: I/O pins are pin 1,2,4,5, GND pins are pin 3,8.

ELECTRICAL CHARACTERISTICS CURVE
Fig 1 Power Derating Curve

Fig 2 Clamping Voltage vs Peak Pulse Current

Fig 3 Voltage Sweeping of I/O to I/O

Fig 4 Voltage vs Capacitance

**Fig 5 ESD Clamping of I/O to GND
(+8kV Contact per IEC 61000-4-2)**

**Fig 6 ESD Clamping of I/O to GND
(-8kV Contact per IEC 61000-4-2)**


DFN2510 PACKAGE OUTLINE DIMENSIONS


Symbol	Dimensions (mm)		
	Min.	Nom.	Max.
D	2.45	2.50	2.55
E	0.95	1.00	1.05
b1	0.35	0.40	0.45
b2	0.20REF		
b	0.15	0.20	0.25
L	0.33	0.38	0.43
Nd	2.00BSC		
e	0.50BSC		
R	0.10	0.125	0.15
A	0.45	0.50	0.55
c	0.15REF		
A1	0.00	-	0.05